

## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

### Title of Invention

Printed Circuit Board with Isolated Metallic Substrate Comprising an  
Integrated Cooling System

Application Number :

Date :

First Named Applicant: Carles Borrego Bel

Confirmation Number:

Attorney Docket Number: 8134ES

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Submitted By:

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Elec. Sign.

Bruce E Harang

Sign. Capacity

Attorney

Documents being submitted:	Files
us-fee-sheet	8134ES-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-ids	8134ES-usidst.xml us-ids.dtd us-ids.xsl
us-request	8134ES-usrequ.xml us-request.dtd us-request.xsl
application-body	8134ES-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd 8134ES_Figs1-3.TIF 8134ES_Figs4-7.TIF
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